

Electronic Patent Application Fee Transmittal

Application Number:				
Filing Date:				
Title of Invention:	Method and Device For Secure, Insulated and Electrically Conductive Assembling of Treated Semiconductor Wafers			
First Named Inventor:	Roy KNETCHTEL			
Filer:	Rodger L. Tate/Mildred Ayim			
Attorney Docket Number:	60291.000048			
Filed as Large Entity				
U.S. National Stage under 35 USC 371 Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
National Stage Fee	1631	1	300	300
Natl Stage Search Fee - Report provided	1642	1	400	400
National Stage Exam - all other cases	1633	1	200	200
Pages:				
Claims:				
Miscellaneous-Filing:				
Eng. Transl. > 30 mo. from priority date	1618	1	130	130
Petition:				